

Maximum Ratings (@ $T_A = +25^{\circ}C$, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _{RM}	45	٧
Average Rectified Output Current	Ιο	10	Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	180	Α

Thermal Characteristics

Characteristic		Symbol	Value	Unit
Typical Thermal Resistance Thermal Resistance Junction to Ambient (Note 5) Thermal Resistance Junction to Ambient (Note 6)		$R_{ hetaJA}$ $R_{ hetaJA}$	102 60	°C/W
Operating Temperature Range	$V_R \le 80\% V_{RRM}$ $V_R \le 50\% V_{RRM}$ DC Forward Mode	T_J	-65 to +150 ≤180 ≤200	°C
Storage Temperature Range		T _{STG}	-65 to +175	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

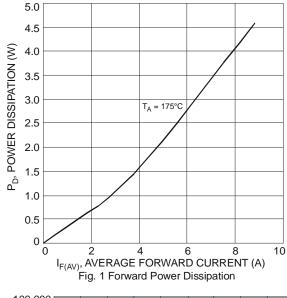
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 7)	$V_{(BR)R}$	45	-	=	V	$I_R = 0.5 \text{mA}$
Forward Voltage Drop	V _F	1 1	0.39 0.46	- 0.53	\ \ \	I _F = 5A, T _J = +25°C I _F = 10A, T _J = +25°C
Leakage Current (Note 7)	I_{R}	-	-	400	μΑ	$V_R = 45V, T_J = +25^{\circ}C$

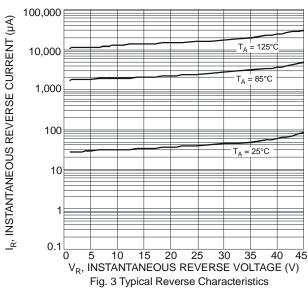
Notes:

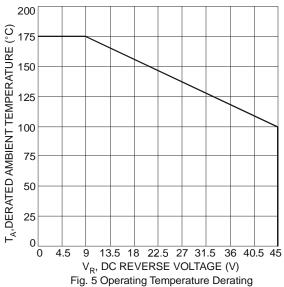
- 5. FR-4 PCB, 2oz. Copper, minimum recommended pad layout per http://www.diodes.com.
- 6. Polymide PCB, 2oz. Copper, minimum recommended pad layout per http://www.diodes.com.
- 7. Short duration pulse test used to minimize self-heating effect.

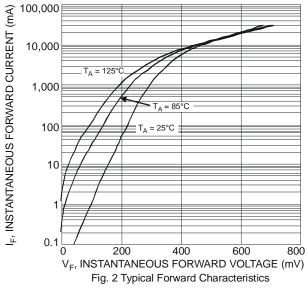


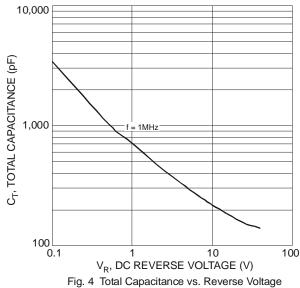










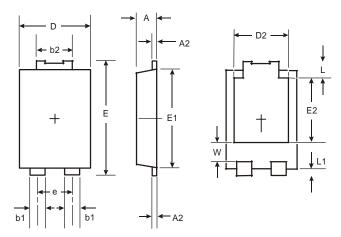


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| Based on Lead Temp (T_L)
| Carrow Control (Carrow Control (C



Package Outline Dimensions

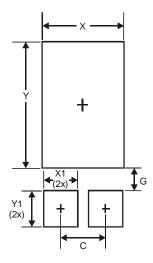
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



POWERDI5				
Dim	Min	Max		
Α	1.05	1.15		
A2	0.33	0.43		
b1	0.80	0.99		
b2	1.70	1.88		
D	3.90	4.05		
D2	3.054 Typ			
Е	6.40	6.60		
е	1.84 Typ			
E1	5.30	5.45		
E2	3.549 Typ			
L	0.75	0.95		
L1	0.50	0.65		
W	1.10	1.41		
All Dimensions in mm				

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
С	1.840
G	0.852
Х	3.360
X1	1.390
Y	4.860
Y1	1.400



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